## FAIRCHILD

SEMICONDUCTOR TM

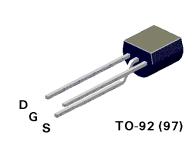
### BS270 N-Channel Enhancement Mode Field Effect Transistor

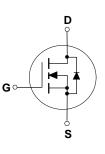
#### **General Description**

These N-Channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 500mA DC. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

#### Features

- 400mA, 60V.  $R_{DS(ON)} = 2\Omega @ V_{GS} = 10V.$
- High density cell design for low R<sub>DS(ON)</sub>.
- Voltage controlled small signal switch.
- Rugged and reliable.
- High saturation current capability.





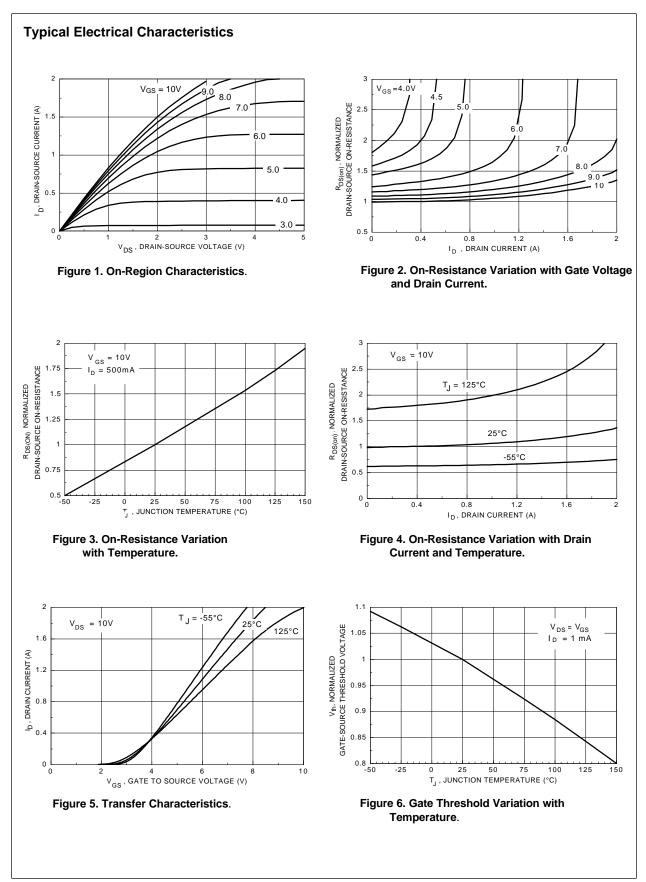
#### **Absolute Maximum Ratings** $T_A = 25^{\circ}C$ unless otherwise noted

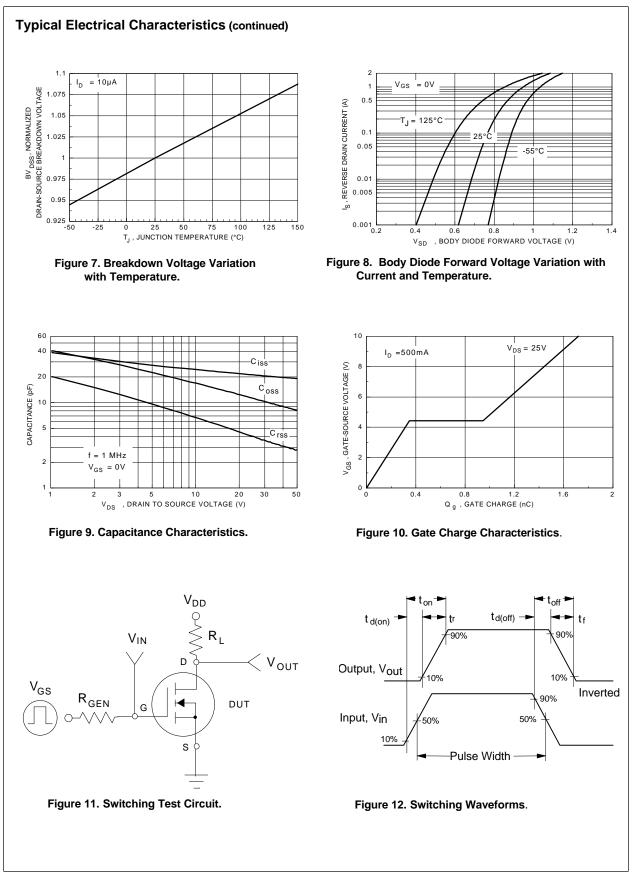
Symbol	Parameter	BS270	Units
V <sub>DSS</sub>	Drain-Source Voltage	60	V
$V_{\text{DGR}}$	Drain-Gate Voltage ( $R_{gs} \le 1M\Omega$ )	60	V
V <sub>GSS</sub>	Gate-Source Voltage - Continuous	±20	V
	- Non Repetitive (tp < 50µs)	±40	
Ι <sub>D</sub>	Drain Current - Continuous	400	mA
	- Pulsed	2000	
P <sub>D</sub>	Maximum Power Dissipation	625	mW
	Derate Above 25°C	5	mW/°C
T_,,T <sub>stg</sub>	Operating and Storage Temperature Range	-55 to 150	°C
TL	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds	300	°C
THERMA	L CHARACTERISTICS		
R <sub>eja</sub>	Thermal Resistacne, Junction-to-Ambient	200	°C/W

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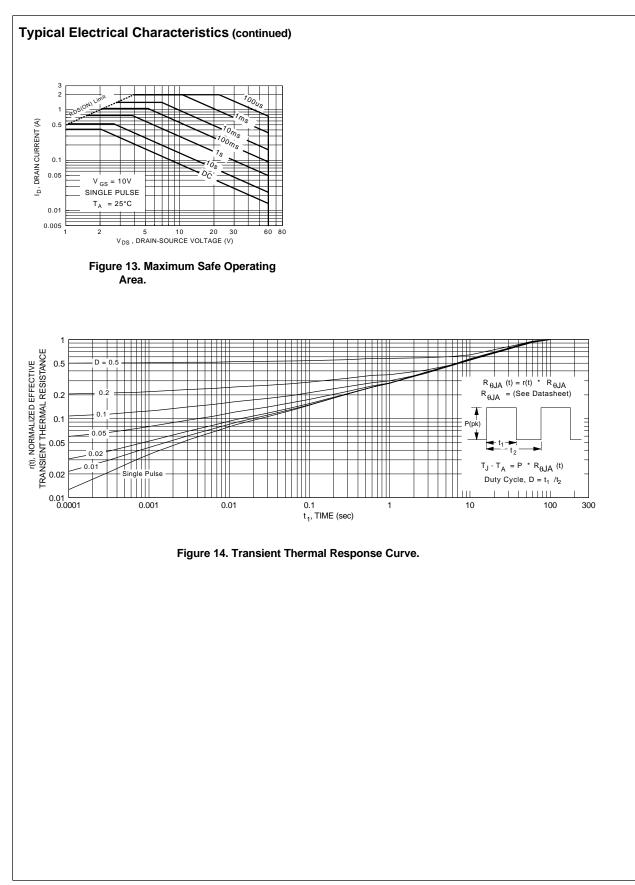
April 1995

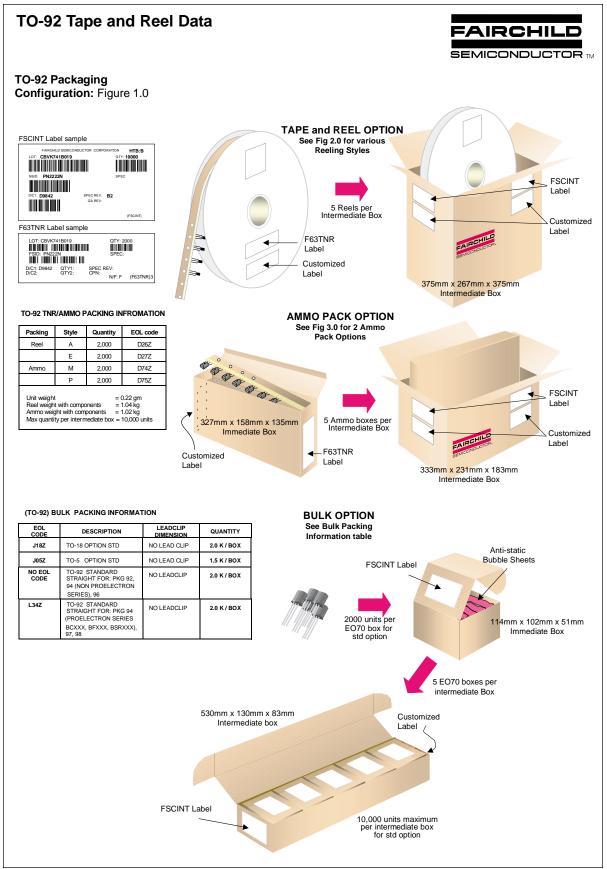
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAP	RACTERISTICS	·		•			
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{gs} = 0 V, I_{p} = 10 \mu A$		60			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\rm DS} = 60 \text{ V}, V_{\rm GS} = 0 \text{ V}$				1	μA
			T <sub>J</sub> = 125°C			500	μA
GSSF	Gate - Body Leakage, Forward	V <sub>gs</sub> = 20 V, V <sub>Ds</sub> = 0 V				10	nA
GSSF	Gate - Body Leakage, Reverse	$V_{gg} = -20 \text{ V}, \text{ V}_{Dg} = 0 \text{ V}$				-10	nA
ON CHAR	ACTERISTICS (Note 1)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA		1	2.1	2.5	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{gg} = 10 \text{ V}, I_{p} = 500 \text{ mA}$			1.2	2	Ω
			T <sub>J</sub> = 125°C		2	3.5	
		$V_{gg} = 4.5 \text{ V}, I_{p} = 75 \text{ mA}$			1.8	3	
V <sub>DS(ON)</sub>	Drain-Source On-Voltage	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 500 \text{ mA}$			0.6	1	V
		$V_{GS} = 4.5 \text{ V}, \ I_{D} = 75 \text{ mA}$			0.14	0.225	
D(ON)	On-State Drain Current	$V_{gg} = 10 \text{ V}, V_{Dg} \ge 2 V_{DS(on)}$		2000	2700		mA
		$V_{\text{GS}} = 4.5 \text{ V}, \ V_{\text{DS}} \ge 2 \text{ V}_{\text{DS(on)}}$		400	600		
9 <sub>FS</sub>	Forward Transconductance	$V_{\text{DS}} \ge 2 V_{\text{DS(on)}}, I_{\text{D}} = 200 \text{ mA}$		100	320		mS
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{\rm DS} = 25  \text{V}, \ V_{\rm GS} = 0  \text{V},$			20	50	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz			11	25	pF
C <sub>rss</sub>	Reverse Transfer Capacitance				4	5	pF
SWITCHIN	G CHARACTERISTICS (Note 1)						
on	Turn-On Time	$V_{\text{DD}} = 30 \text{ V}, \text{ I}_{\text{D}} = 500 \text{ m A}, \\ V_{\text{GS}} = 10 \text{ V}, \text{ R}_{\text{GEN}} = 25 \Omega$				10	ns
off	Turn-Off Time					10	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS AND	D MAXIMUM RATINGS					
s	Maximum Continuous Drain-Source Diode Forward Current					400	mA
SM	Maximum Pulsed Drain-Source Diode Forward Current				2000	mA	
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 400 \text{ mA} \text{ (Note 1)}$			0.88	1.2	V





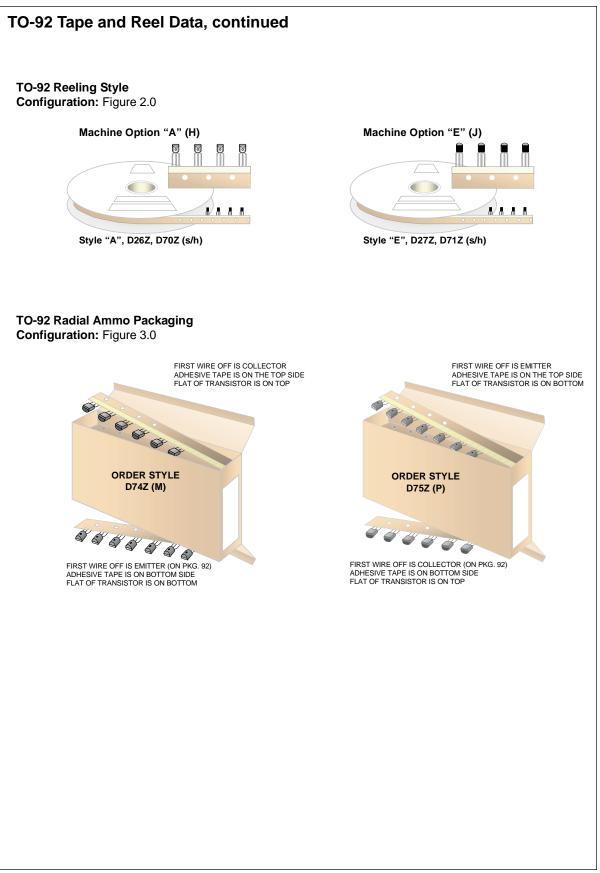
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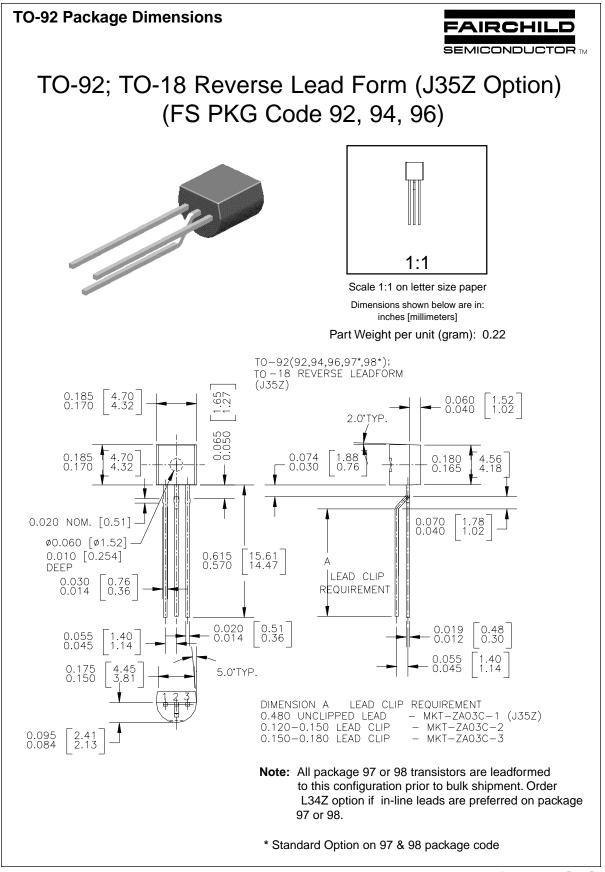
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